WHAT IS CLAIMED IS:

- 1 1. An apparatus for socketing and testing integrates
- 2 circuits comprising:
- an air machine; and
- a housing comprising (i) a printed circuit board that
- 5 is operable to receive a device under test, and (ii) a controller
- 6 that is operable to control testing of the received device under
- 7 test;
- wherein said air machine is associable with said
- 9 housing to form an at least substantially air-tight chamber
- 10 ensconcing the received device under test.
- 1 2. The apparatus as set forth in Claim 1 wherein said
 - housing further comprises a power supply.
- 1 3. The apparatus as set forth in Claim 1 wherein said
- printed circuit board is circular shaped.
- 1 4. The apparatus as set forth in Claim 3 wherein said
- 2 housing further comprises I/O connectors that are placed
- 3 circumferentially and symmetrically near the edge of the printed
- 4 circuit board.

- 5. The apparatus as set forth in Claim 3 wherein said
- printed circuit board comprises a leadless socket.
- 1 6. The apparatus as set forth in Claim 5 wherein said
- leadless socket is operable to receive the device under test in
- 3 the center of the Printed circuit board.

- 7. A method of operating an apparatus for socketing and
- 2 testing integrated circuits, said apparatus comprising an air
- 3 machine and a housing, said housing comprising a printed circuit
- 4 board and a controller, said method comprising the steps of
- 5 (i) receiving a device under test, and (ii) associating said air
- 6 machine with said housing to form an at least substantially air-
- 7 tight chamber ensconcing the received device under test.
- 1 8. The method as set forth in Claim 7 wherein said housing
- 2 further comprises a power supply, and said method comprising the
- 3 step of powering on the apparatus.
- 9. The method as set forth in Claim 7 wherein said printed
- 2 circuit board is circular shaped, and said method comprising the
- step of controlling testing of the received device under test
- with said controller.
- 1 10. The method as set forth in Claim 9 wherein said housing
- 2 further comprises I/O connectors that are placed
- 3 circumferentially and symmetrically near the edge of the printed
- 4 circuit board.
- 1 11. The method as set forth in Claim 9 wherein said printed
- 2 circuit board comprises a leadless socket.

- 1 12. The method as set forth in Claim 11 wherein said
- 2 leadless socket is operable to receive the device under test in
- the center of the Printed circuit board.

- 1 13. An apparatus for socketing and testing integrated
- 2 circuits comprising:
- an air machine; and
- a housing comprising (i) a universal printed circuit
- 5 board that is operable to receive a device under test, (ii) a
- 6 controller that is operable to control testing of the received
- device under test, and (ii) a power supply;
- wherein said air machine is associable with said
- 9 housing to form an at least substantially air-tight chamber
- 10 ensconcing the received device under test.
 - 1 14. The apparatus as set forth in Claim 13 wherein said
- 2 power supply is a battery.
- 15. The apparatus as set forth in Claim 13 wherein said
- 2 universal printed circuit board is circular shaped.
- 1 16. The apparatus as set forth in Claim 15 wherein said
- 2 housing further comprises I/O connectors that are placed
- 3 circumferentially and symmetrically near the edge of the
- 4 universal printed circuit board.
- 1 17. The apparatus as set forth in Claim 15 wherein said
- 2 printed circuit board comprises a leadless socket.

- 1 18. The apparatus as set forth in Claim 17 wherein said
- leadless socket is operable to receive the device under test in
- the center of the printed circuit board.
- 1 19. The apparatus as set forth in Claim 13 wherein the
- 2 device under test is one of a RF integrated circuit and a
- high-frequency integrated circuit.
- 1 20. The apparatus as set forth in Claim 17 wherein said
- leadless socket is self-registering.